



Product Change Notification

Change Notification #: 118031 - 00
Change Title: Select Intel® Optane™ SSD 800P Series SKUs, PCN 118031-00, Product Discontinuance, End of Life
Date of Publication: January 14, 2021

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	January 11, 2021
Last Product Discontinuance Shipment Date:	February 26, 2021

Description of Change to the Customer:

Intel is announcing the End of Life timeline for the Intel® Optane™ SSD 800P Series for the SKUs listed in the Product Affected table below.

The Intel® Optane™ SSD 800P Series products listed on the "Products Affected/Intel Ordering Codes" table below will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date."

Effective "Last Ship Date" Intel will stop shipping Intel® Optane™ SSD 800P Series.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand for the products listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above.

Intel will make commercially reasonable efforts to support last time order quantities.

The Intel® Optane™ Memory H20 with Solid State Storage is the recommended transition product for the 800P.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#
Intel® Optane™ SSD 800P Series (58GB, M.2 80mm PCIe 3.0, 3D XPoint™) Generic Single Pack	SSDPEK1W060GA01	960258
Intel® Optane™ SSD 800P Series (118GB, M.2 80mm PCIe 3.0, 3D XPoint™) Generic Single Pack	SSDPEK1W120GA01	960259
Intel® Optane™ SSD 800P Series (58GB, M.2 80mm PCIe 3.0, 3D XPoint™) Generic 100 Pack	SSDPEK1W060GA	960266
Intel® Optane™ SSD 800P Series (118GB, M.2 80mm PCIe 3.0, 3D XPoint™) Generic 100 Pack	SSDPEK1W120GA	960267
Intel® Optane™ SSD 800P Series (58GB, M.2 80mm PCIe 3.0, 3D XPoint™) Retail Box 10 Pack.	SSDPEK1W060GAXT	962394
Intel® Optane™ SSD 800P Series (118GB, M.2 80mm PCIe 3.0, 3D XPoint™) Retail Box 10 Pack	SSDPEK1W120GAXT	962395
Intel® Optane™ SSD 800P Series (118GB, M.2 80mm PCIe 3.0, 3D XPoint™) Retail Box Single Pack	SSDPEK1W120GAX1	962396

PCN Revision History:

Date of Revision:

January 12, 2021

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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